



Line #	aterials			Layer Stack Legend					
· · · · · · · · · · · · · · · · · · ·	Designator C1, C7, C8, C9, C10, C11,	Comment	Quantity		Material	Layer	Thickness Dielectric Materia	• .	Gerber
	C12, C13, C14, C15, C16,	400 5				Top Overlay		Legend	GTO
	C17, C18, C21, C30, C32, C34, C35, C36, C37, C38,	100nF	25		——— Surface Material	Top Solder	0.02mm SM-001	Solder Mask	GTS
	C39, C40, C41, C42	4	1		PbSn	Top Surface Finish	0.02mm	Surface Finish	
	C2 C3	1uF 10nF	1		CF-004	Top Layer	0.04mm	Signal	GTL
	C4, C19, C26, C27, C33	4.7uF	5		Prepreg		0.20mm PP-017	Dielectric	
	C5, C6, C20, C22, C24, C28, C29	2.2uF	7		——— CF-004	Int1 (GND)	0.02mm	Signal	G1
	C23, C25, C31	10uF NSVR1020	3		Core	(0.12)	1.06mm Core-039	Dielectric	
	D1 D2	Red	1		——— CF-004	Int2 (PWR)	0.02mm	Signal	G2
0	D3, D4, D6 D5	B0520LW Blue	3		Prepreg		0.20mm PP-017	Dielectric	
1	D7	Green	1		——— CF-004	Bottom Layer	0.04mm	Signal	GBL
2	FB1 J1, J4	120R-30mRDC 800mA	1 2		—— PbSn	Bottom Surface Finish		Surface Finish	
4	J2	micro USB B	1	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\					
5	J3 J5	SMD_PAD NT35510	1		——— Surface Material		0.02mm SM-001	Solder Mask	GBS
) 7	J6	OV7670	1	_	Total thickness 4 C	Bottom Overlay		Legend	GBO
3	L1 Q1	39nH NTS4101PT1G	1		Total thickness: 1.6	omm			
)	Q2, Q3	2N7002	2						
1	Q4, Q6 Q5	BSS84L BSS223PW	2						
1 2 3 4 5 6 7	Q7	BSS123	1						
1	R1, R3, R5, R18, R23 R2, R11, R14, R20, R21, R22	1MR 100kR	5						
5	R4, R6	0R	2						
	R7, R10, R16 R8, R9, R12, R13, R28, R31,	2.2kR	3						
3	R34, R35	10kR	8						
)	R15 R17	1kR 56kR	1						
)) 	R19	680kR	1						
2	R24, R25, R26, R27 R29, R30	22R 150R	2						
1	R32, R33	4.7kR	2						
3 4 5 6 7 7 8	S1 U1	50mA STM32F413ZHT6	1						
7	U2	MIC5357	1						
3	U3 U4	MCP73831T USBLC6-2SC6	1						
Q \	4 01	CH340C	<u> </u>						

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